Specifications for Approval

Customer Part No.:

Inhere Part No.: LRUB12693-A01

Part Name: 2*3*4 方形无边水清透明红蓝双色共阴 LED

Spec Issue Date: 2018-07-21

Revision No.: A

Ne submit herewi	th the following information for	your approval:
Sample	\Box OQC Inspection Record	LED Dimension
Electrical Cha	racteristics Curve	ternal Circuit Diagram
Soldering reco	ommendation	
Prepared by: Lily	Checked by: Tor	m Approved by: Wangxiaojur
Date: 2018-07-21	Date: 2018-07-2	21 Date: 2018-07-21

Reject with the following reason:

Approve and no objection



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SPECIFICATIONS

Features

- High speed response.
- High reliability and long life.
- Low power consumption.
- Available in red, orange, yellow, yellow-green, green, blue, white, pink*
- Suitable for pulse operation.
- RoHS compliant.

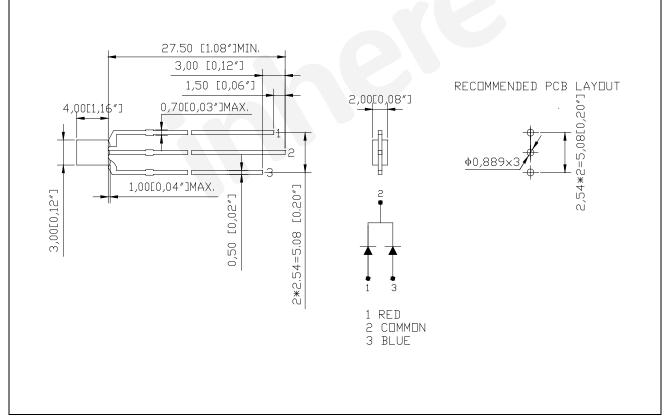
Description

- The Red source color devices are made with AlGaInP on GaAs Light Emitting Diode.
- The Blue source color devices are made with InGaN/GaN on Al₂O₃ Light Emitting Diode.

Applications

- Consumer electronics
- Display boards
- Indicators

Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25 \ 0.01")$ unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.

4. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Functionis and a loss		$\mathrm{I_{V}}$ (mcd) @ 20mA		Viewing Angle(°)	
Part No.	Dice	Emitting Color	Lens Type	Min.	Тур.	$2\theta_{\frac{1}{2}}$	
	AlGaInP	Red	Wator Class	100	250	120	
LRUB12693-A01	InGaN	Blue	Water Clear	250	400	120	

Note:

1. $\theta_{\frac{1}{2}}$ is the angle from optical centerline where the luminous intensity is $\frac{1}{2}$ the optical centerline value.

2. The tolerance of luminous intensity (Iv)is $\pm 15\,\%$.

Electrical / Optical Characteristics (at $T_a = 25^{\circ}C$)

Parameter	Symbol	Color	Value			Unit	Test Condition		
Falameter	Symbol	000	Min.	Тур.	Max.	Onit	lest condition		
Forward Voltage	V	Red	1.8		2.5	v	L = 20mA		
Forward voltage	$V_{\rm F}$	Blue	2.8		3.5	V	$I_F = 20 \text{mA}$		
Dominant Wavelength	λ_{D}	Red	620		630		L = 20m A		
Dominant Wavelength		Blue	465		475	nm	I _F = 20mA		
Boyorso Current	rse Current I _R	Red	Red		10	10		И БУ	
Reverse Current		Blue			10	μA	$V_{R} = 5V$		

Note:

1 The tolerance of forward voltage is $\pm\,0.05V$

2 The tolerance of dominant wavelength is ±1nm.

3. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

Absolute Maximum Ratings (at $T_a = 25^{\circ}C$)

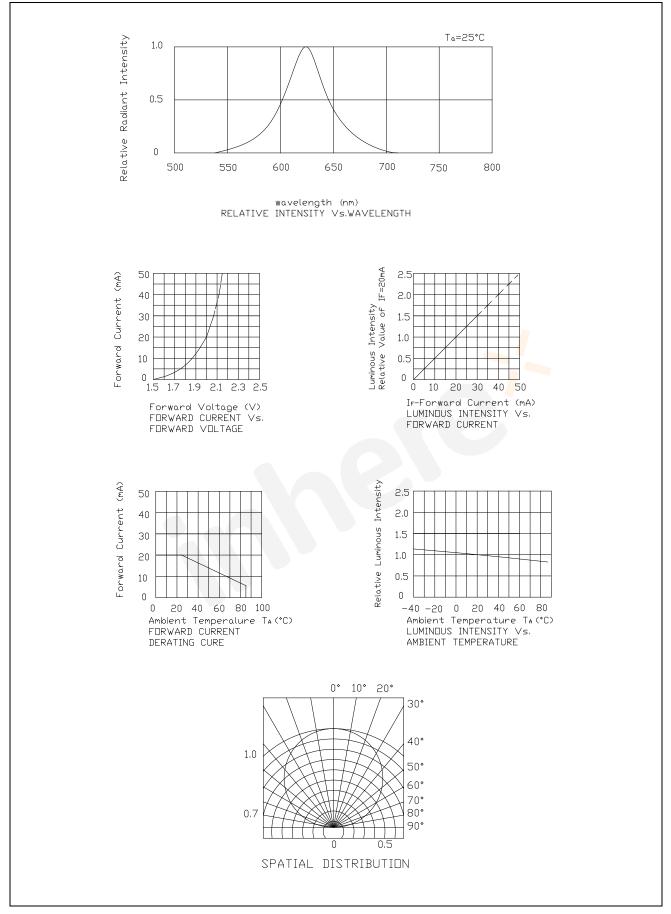
	Sumbol	Value		- Unit	
Parameter	Symbol	R B			
Power Dissipation	P _D	75	105	mW	
Pulse Forward Current(Duty 1/10 @ 1 kHz)	$I_{\rm FP}$	100		mA	
Forward Current	$I_{\rm F}$	30		mA DC	
Reverse Voltage	V _R	5		V DC	
Operating Temperature	T _{opr}	-40 ~ +85		°C	
Storage Temperature	T _{stg}	-40 ~ +85		°C	
Soldering Temperature	T _{sld}	260°C for 5 sec		for 5 sec	

Date: 2018-07-21 Approved by: Wangxiaojun

Reliability Testing Conditions

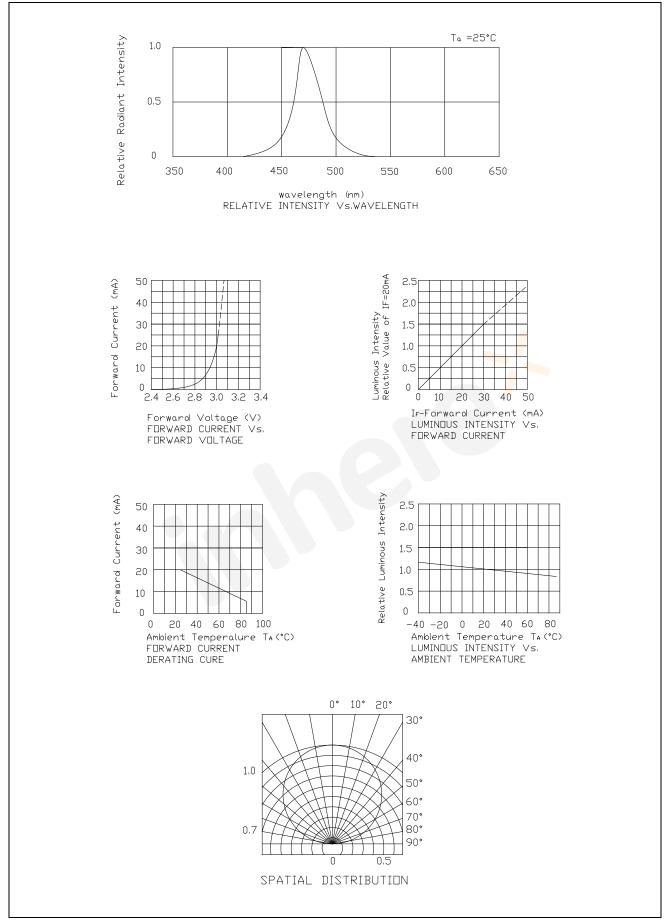
NO	Test Item	Test Conditions	Duration	Sample	Ac/Re
1	Temperature Cycle	-40℃±5℃~25℃±5℃~100℃±5℃~25℃±5℃ 30min 5min 30min 5min	100clycles	22	0/1
2	High Temp. Storage	Ta=100℃±5℃	1000hours	22	0/1
3	Temp.& Humidity Test	Ta=85℃±5℃ RH=85%±5%	1000hours	22	0/1
4	Low Temp. Storage	Ta=-40 °C ±5 °C	1000hours	22	0/1
5	Operating Life Test	Ta=25±5℃ DC IF=20mA	1000hours	22	0/1
6	Solder Heat	Tsol=260±5℃,5s	1times	22	0/1
7	Thermal Shock	-40±5℃→100±5℃ 15min 15min	100clycles	22	0/1

Optical Characteristic Curves (Red)



Rev.: A Checked by: Tom

Optical Characteristic Curves (Blue)



Rev.: A Checked by: Tom

Precautions in Use

	1.	Soldering Condition					
		a.	When soldering, leave the minimum clearance between the bottom of the resin and the soldering point.				
		b.	Do not solder closer than 3mm from the base of the epoxy bulb.				
		ы. С.	Maximum allowance soldering conditions are:				
		с.	Dip Soldering: 260°C max., 5 sec Max., 1 time.				
			Soldering iron: 350°C max., 5 sec Max., 1 time.				
		Ч					
		d.	Contact between molten solder and the resin shall be avoided.				
		e.	During soldering, do not put any stress on the lead frame, particularly when heated.				
	2.	Lea	nd frame Forming and Use				
		a.	When forming leads, the leads shall be bent at a point at least 3mm from the base of epoxy bulb. Do				
			not use the base of the lead frame as a fulcrum during lead forming.				
		b.	Lead forming shall be done before soldering.				
		c.	Do not apply any bending stress to the base of the lead. The stress to the base may damage the LED's				
			characteristics or it may break the LED.				
		d.	When mounting the LED onto a printed circuit board, the holes on the PCB shall be exactly aligned with				
			the leads of the LED. If the LED is mounted with stress at the leads, it may cause deterioration of the				
			epoxy resin and this may degrade the LED.				
		e.	Avoid condition which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration				
			may cause difficulty during soldering operation. It is recommended that the LED be used as soon as				
			possible.				
		f.	Avoid rapid transition in ambient temperature, especially in high humidity environment.				
	3.	Sta	tic Electricity				
		a.	The product is sensitive to static electricity charge, and user is required to handle it with care.				
			Particularly, if a current and/or voltage which exceed the Absolute Maximum Rating of the Product is				
			applied, the overflow in energy may cause damage to, or possibly result in electrical destruction of, the				
			LED. The customer is requested to take adequate countermeasure against static electricity charge and				
			surge when handling it.				
		b.	Proper grounding, use of conductive mat, conductive working uniform and shoes, and conductive				
			containers are effective against static electricity and surge.				
		с.	Ground low-resistance area where the product contacts, such as metal surface of the work platform,				
			with a conductive mat (surface resistance $10^6 \sim 10^9$ ohm).				
		d.	A tip of soldering iron is requested to be grounded. An ionizer shall also be installed where risk of static				
			generation is high.				
	Not	tes:					
	1.	The	e above specification and dimensions may be modified for product improvement. Inhere reserves the right to				
			nge the specification without notice.				
Į	2.		en using this product, please observe the Absolute Maximum Ratings and the instructions in the specification				
	۷.						
	2.	she	ets. Inhere assumes no responsibility for any damage resulting from use of the product that does not comply				